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Our work

- High-speed and long distance signal transmission in a 90nm technology
- 10Gbps/ch signaling on 3mm on-chip transmission-line
 - Maximum bandwidth: <u>12.5Gbps</u>
- 30% Power reduction of driver by impedance-unmatched CML driver

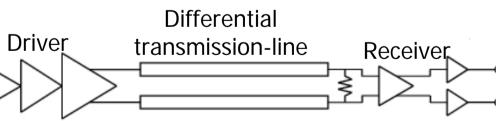


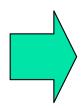
Solution of bottleneck

Bottleneck of on-chip signaling is <u>Driver</u>. CMI is a choice of driver

- Advantage:
 - High-speed operation
 - Higher noise tolerance
- Disadvantage:
 - Large power consumption

Targeted signaling system





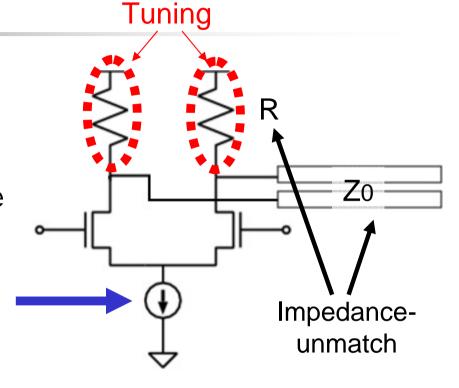
We challenged power reduction of driver.

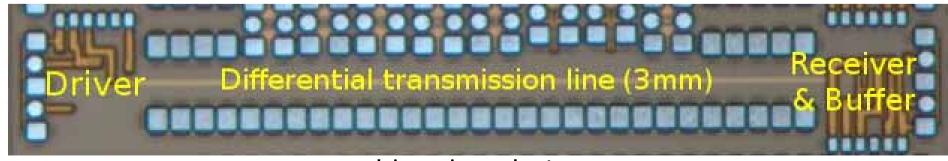
Design idea

Impedance matching at driver output is not mandatory for on-chip signaling

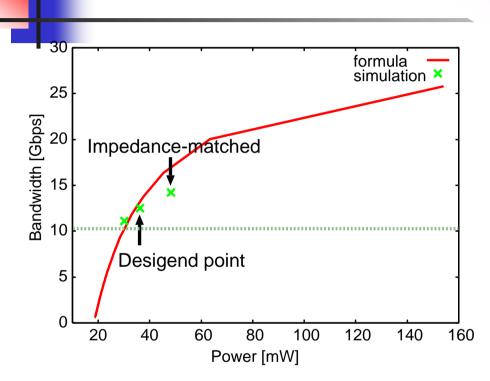
- Wire line is lossy
- Terminator eliminate the reflected wave

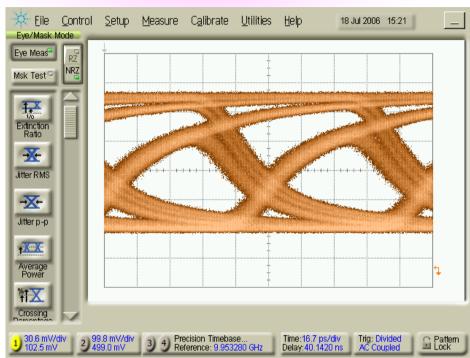
We can tune the tail current by changing the load resistance R.





Measurement results and Conclusion Let's discuss at 1D-15





Trade-off curve between power and bandwidth of driver

Measured eye-diagram (12.5Gbps)

- The maximum signaling speed is <u>12.5Gbps</u>.
- Power consumption reduced by <u>30%</u>.

Thank you